

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
HUAFEI XIE	12/25/2017
RECEIVING PARTY DATA	
Name:	SHENZHEN CHINA STAR OPTOELECTRONICS SEMICONDUCTOR DISPLAY TECHNOLOGY CO., LTD.
Street Address:	NO.9-2, TANGMING ROAD, GONGMING STREET, GUANGMING NEW DISTRICT, GUANGDONG
City:	SHENZHEN
State/Country:	CHINA
Postal Code:	518000
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	15741116
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SIGNATURE:	/Joshua L. Pritchett/
DATE SIGNED:	12/29/2017
Total Attachments: 1 source=EfiledAssign#page1.tif	

ASSIGNMENT

In consideration of the premises and other good and valuable consideration in hand paid, the receipt and sufficiency of which is hereby acknowledged, the undersigned,

1) **Huafei XIE**

who has made a certain new and useful invention, hereby sells, assigns and transfers unto Shenzhen China Star Optoelectronics Semiconductor Display Technology Co., Ltd., having a place of business at No.9-2, Tangming Road, Gongming Street, Guangming New District, Shenzhen, Guangdong 518000, China its successors and assigns (hereinafter designated "ASSIGNEE") the entire right, title and interest for the United States of America as defined in 35 U.S.C. 109 in the invention entitled THIN FILM TRANSISTOR AND MANUFACTURING METHOD THEREOF

(a) for which an application for United States Letters Patent was filed on 2017-12-29, and identified by United States Patent Application No. 15/741,116; or

(b) for which an application for United States Letters Patent was executed on _____,

and the undersigned hereby authorizes and requests the United States Commissioner of Patents and Trademarks to issue my and all United States Letters Patent which may be granted therefore and any and all extensions, divisions, reissues, continuations, or continuations-in-part thereof, and the rights to all benefits under the International Convention for the Protection of Industrial Property to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agrees that the attorneys of record in said application shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agrees to transfer a like interest, and to render all necessary assistance in making application for and obtaining original, divisional, reissued or extended Letters Patent of the United States, upon request of the said ASSIGNEE, its successors, assigns and legal representatives, and without further remuneration, in and to any improvements, and applications for patent based thereon, growing out of or related to the said invention; and to execute any papers by the said ASSIGNEE, its successors, assigns and legal representatives, deemed essential to ASSIGNEE's full protection and title in and to the invention hereby transferred.

SIGNED on the date indicated aside my signature:

1) Huafei XIE
Name: **Huafei XIE**

2017. 12. 25
Date: